# **BLF8G27LS-100V**; BLF8G27LS-100GV Power LDMOS transistor

**AMPLEON** 

Rev. 5 — 1 September 2015

Product data sheet

## **Product profile**

#### 1.1 General description

100 W LDMOS power transistor with improved video bandwidth for base station applications at frequencies from 2500 MHz to 2700 MHz.

Table 1. Typical performance

Typical RF performance at  $T_{case} = 25$  °C in a common source class-AB production test circuit.

Test signal	f	I <sub>Dq</sub>	V <sub>DS</sub>	P <sub>L(AV)</sub>	Gp	$\eta_{D}$	ACPR <sub>5M</sub>
	(MHz)	(mA)	(V)	(W)	(dB)	(%)	(dBc)
2-carrier W-CDMA	2500 to 2700	900	28	25	17	28	-32 [ <u>1]</u>

<sup>[1]</sup> Test signal: 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF per carrier; 5 MHz carrier spacing.

#### 1.2 Features and benefits

- Excellent ruggedness
- High efficiency
- Low R<sub>th</sub> providing excellent thermal stability
- Decoupling leads to enable improved video bandwidth (110 MHz typical)
- Designed for broadband operation (2500 MHz to 2700 MHz)
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent pre-distortability
- Internally matched for ease of use
- Integrated ESD protection
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

#### 1.3 Applications

■ RF power amplifiers for base stations and multi carrier applications in the 2500 MHz to 2700 MHz frequency range

# 2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
BLF8G27	7LS-100V (SOT1244B)		
1	drain		
2	gate	— 4 1 5 ∏	6,7→1 1 4,5
3	source [		2
4	decoupling lead	3	3
5	decoupling lead		aaa-003619
6	n.c.		
7	n.c.	6 2 7	
BLF8G27	7LS-100GV (SOT1244C)		
1	drain	4 4 5	4
2	gate	4 1 5 	6,7 → 1 → 4,5
3	source [	11	2
4	decoupling lead		3
5	decoupling lead	6 2 7	aaa-003619
6	n.c.	6 2 7	
7	n.c.		

<sup>[1]</sup> Connected to flange.

# 3. Ordering information

Table 3. Ordering information

Type number	Package			
	Name	Description	Version	
BLF8G27LS-100V	-	earless flanged ceramic package; 6 leads	SOT1244B	
BLF8G27LS-100GV	-	earless flanged ceramic package; 6 leads	SOT1244C	

# 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Parameter	Conditions	Min	Max	Unit
drain-source voltage		-	65	V
gate-source voltage		-0.5	+13	V
storage temperature		-65	+150	°C
junction temperature		-	225	°C
	drain-source voltage gate-source voltage storage temperature	drain-source voltage gate-source voltage storage temperature	drain-source voltage - gate-source voltage -0.5 storage temperature -65	drain-source voltage - 65 gate-source voltage -0.5 +13 storage temperature -65 +150

#### 5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R <sub>th(j-c)</sub>	thermal resistance from junction to case	$T_{case} = 80  ^{\circ}C;  P_{L} = 48  W$	0.292	K/W

#### 6. Characteristics

Table 6. DC characteristics

 $T_i = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 1 \text{ mA}$	65	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$V_{DS}$ = 10 V; $I_{D}$ = 153 mA	1.5	1.9	2.3	V
I <sub>DSS</sub>	drain leakage current	$V_{GS} = 0 \text{ V}; V_{DS} = 28 \text{ V}$	-	-	4.2	μΑ
I <sub>DSX</sub>	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 V;$ $V_{DS} = 10 V$	-	29	-	Α
I <sub>GSS</sub>	gate leakage current	$V_{GS} = 11 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	420	nA
g <sub>fs</sub>	forward transconductance	$V_{DS}$ = 10 V; $I_{D}$ = 153 mA	-	1.27	-	S
R <sub>DS(on)</sub>	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 V;$ $I_D = 5.35 A$	-	0.1	-	Ω

#### Table 7. RF characteristics

Test signal: 2-carrier W-CDMA, 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on the CCDF;  $f_1$  = 2502.5 MHz;  $f_2$  = 2507.5 MHz;  $f_3$  = 2692.5 MHz;  $f_4$  = 2697.5 MHz; RF performance at  $V_{DS}$  = 28 V;  $I_{Dq}$  = 900 mA;  $I_{Case}$  = 25 °C; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	$P_{L(AV)} = 25 W$	15.8	17	-	dB
$\eta_{D}$	drain efficiency	$P_{L(AV)} = 25 W$	25	28	-	%
RLin	input return loss	$P_{L(AV)} = 25 W$	-	-10	-	dB
ACPR <sub>5M</sub>	adjacent channel power ratio (5 MHz)	$P_{L(AV)} = 25 W$	-	-32	-26	dBc

#### 7. Test information

#### 7.1 Ruggedness in class-AB operation

The BLF8G27LS-100V and BLF8G27LS-100GV are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS}$  = 28 V;  $I_{Dq}$  = 900 mA;  $P_{L}$  = 100 W; f = 2500 MHz.

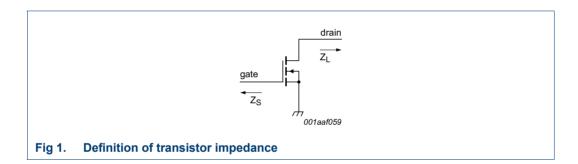
## 7.2 Impedance information

Table 8. Typical impedance

Measured load-pull data;  $I_{Dq} = 900 \text{ mA}$ ;  $V_{DS} = 28 \text{ V}$  (main transistor).

f	Z <sub>S</sub> [1]	Z <sub>L</sub> [1]
(MHz)	$(\Omega)$	(Ω)
BLF8G27LS-100V		
2500	1.2 – j4.6	2.7 – j2.7
2600	2.3 – j5.5	2.5 – j2.5
2700	3.8 – j5.2	2.1 – j2.6
BLF8G27LS-100GV		
2500	1.7 – j7.4	2.4 – j4.9
2600	2.8 – j8.0	2.2 – j5.2
2700	4.0 – j7.9	2.0 – j5.3

[1]  $Z_S$  and  $Z_L$  defined in Figure 1.



#### 7.3 VBW in class-AB operation

The BLF8G27LS-100V and BLF8G27LS-100GV show 110 MHz (typical) video bandwidth in class-AB test circuit in 2.6 GHz band at  $V_{DS}$  = 28 V and  $I_{Dq}$  = 0.9 A.

#### 7.4 Test circuit

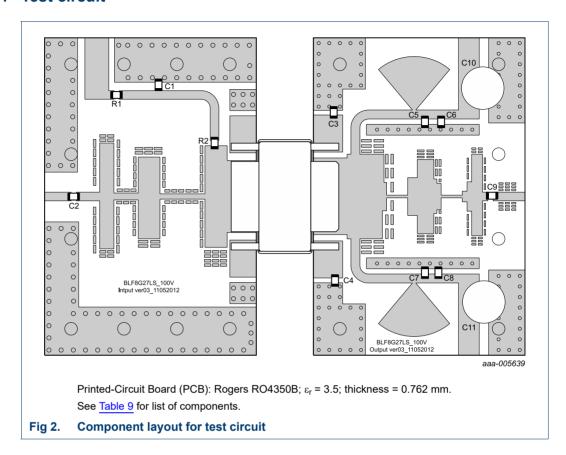


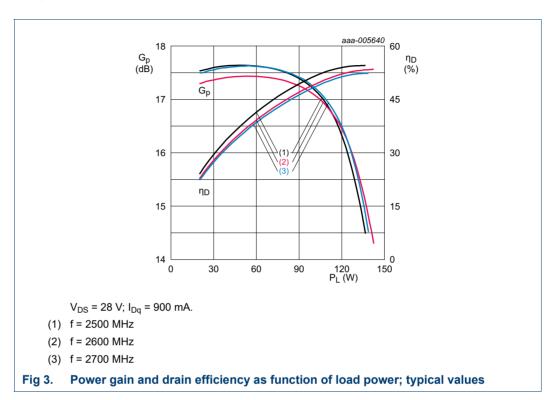
Table 9. List of components

For test circuit, see Figure 2.

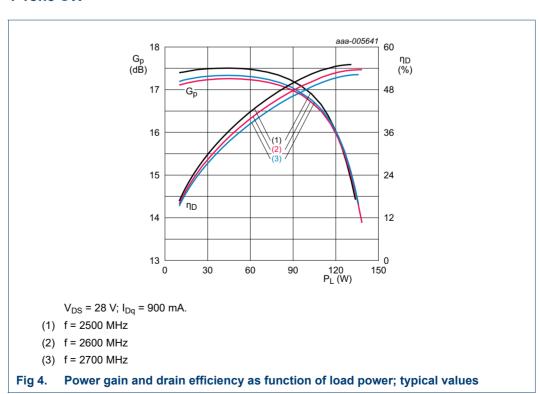
Component	Description	Value	Remarks
C1, C2, C9	multilayer ceramic chip capacitor	20 pF	ATC600F
C3, C4, C6, C8	multilayer ceramic chip capacitor	10 μF	Murata
C5, C7	multilayer ceramic chip capacitor	0.1 μF	Murata
C10, C11	electrolytic capacitor	1000 μF, 100 V	
R1, R2	chip resistor	9.1 Ω	Vishay Dale SMD 0805

#### 7.5 Graphical data

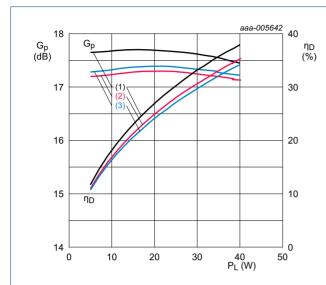
#### 7.5.1 Pulsed CW



#### 7.5.2 1-Tone CW



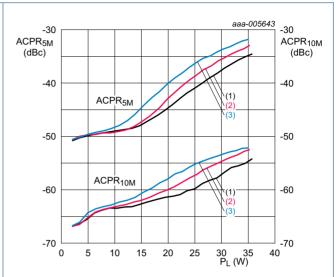
#### 7.5.3 1-Carrier W-CDMA



 $V_{DS} = 28 \text{ V}; I_{Dq} = 900 \text{ mA}.$ 

- (1) f = 2500 MHz
- (2) f = 2600 MHz
- (3) f = 2700 MHz

Fig 5. Power gain and drain efficiency as function of load power; typical values

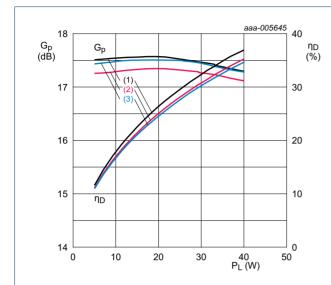


 $V_{DS}$  = 28 V;  $I_{Dq}$  = 900 mA.

- (1) f = 2500 MHz
- (2) f = 2600 MHz
- (3) f = 2700 MHz

Fig 6. Adjacent channel power ratio (5 MHz) and Adjacent channel power ratio (10 MHz) as function of load power; typical values

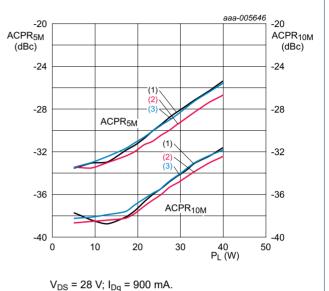
#### 7.5.4 2-Carrier W-CDMA



 $V_{DS} = 28 \text{ V}; I_{Dq} = 900 \text{ mA}.$ 

- (1) f = 2500 MHz
- (2) f = 2600 MHz
- (3) f = 2700 MHz

Fig 7. Power gain and drain efficiency as function of load power; typical values

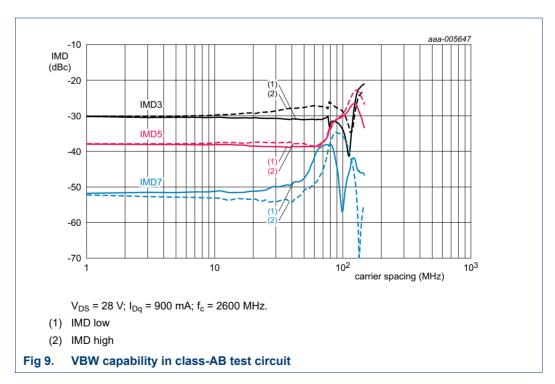


(1) f = 2500 MHz

- (2) f = 2600 MHz
- (3) f = 2700 MHz

Fig 8. Adjacent channel power ratio (5 MHz) and Adjacent channel power ratio (10 MHz) as function of load power; typical values

#### 7.5.5 2-Tone VBW



## 8. Package outline

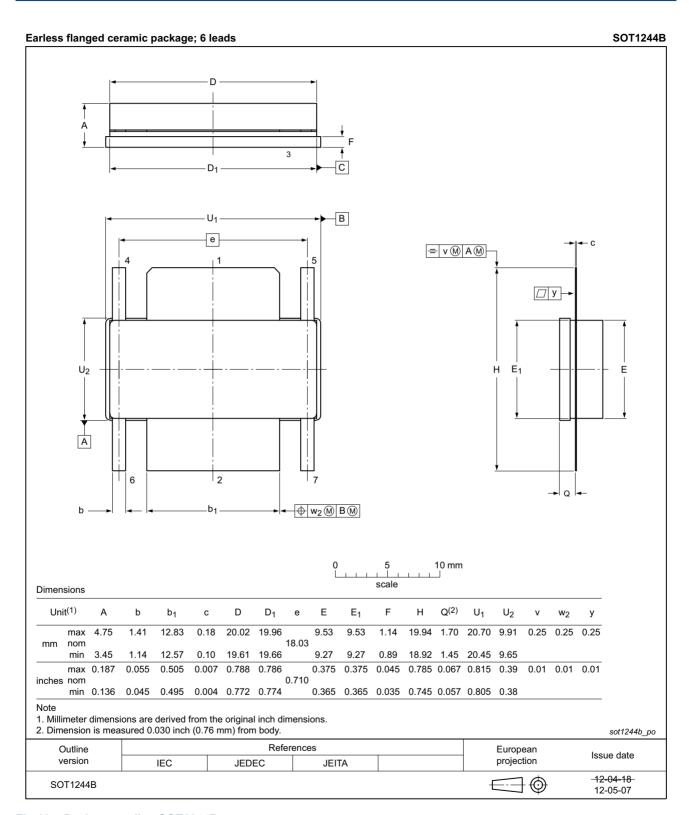


Fig 10. Package outline SOT1244B

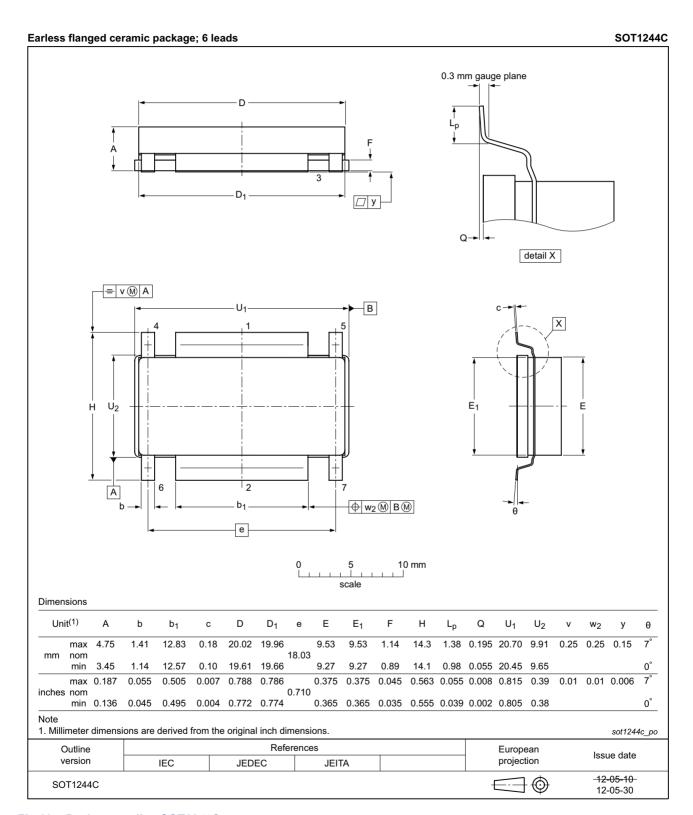


Fig 11. Package outline SOT1244C

# 9. Handling information

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

## 10. Abbreviations

Table 10. Abbreviations

Acronym	Description	
3GPP	Third Generation Partnership Project	
CCDF	Complementary Cumulative Distribution Function	
CW	Continuous Wave	
DPCH	Dedicated Physical CHannel	
ESD	ElectroStatic Discharge	
IMD	InterModulation Distortion	
LDMOS	Laterally Diffused Metal Oxide Semiconductor	
PAR	Peak-to-Average Ratio	
SMD	Surface Mounted Device	
VBW	Video BandWidth	
VSWR	Voltage Standing Wave Ratio	
W-CDMA	Wideband Code Division Multiple Access	

# 11. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
BLF8G27LS-100V_27LS-100GV#5	20150901	Product data sheet		BLF8G27LS-100V_27L S-100GV v.4	
Modifications:	<ul> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> </ul>				
	Legal texts have been adapted to the new company name where appropriate.				
BLF8G27LS-100V_27LS-100GV v.4	20130926	Product data sheet	-	BLF8G27LS-100V v.3	
BLF8G27LS-100V v.3	20130129	Product data sheet	-	BLF8G27LS-100V v.2	
BLF8G27LS-100V v.2	20121203	Product data sheet	-	BLF8G27LS-100V v.1	
BLF8G27LS-100V v.1	20120817	Objective data sheet	-	-	

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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**Power LDMOS transistor** 

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# BLF8G27LS-100(G)V

**Power LDMOS transistor** 

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